

## DS8641 Quad Unified Bus Transceiver

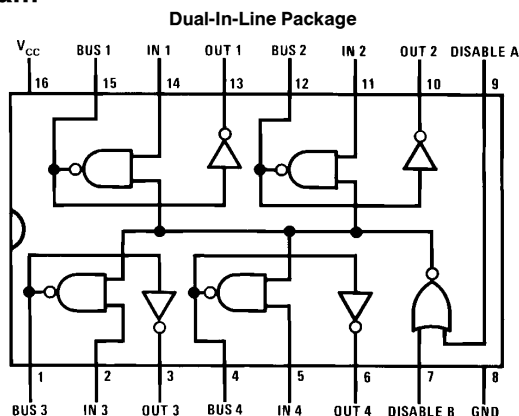
### General Description

The DS8641 is a quad high speed drivers/receivers designed for use in bus organized data transmission systems interconnected by terminated  $120\Omega$  impedance lines. The external termination is intended to be a  $180\Omega$  resistor from the bus to the +5V logic supply together with a  $390\Omega$  resistor from the bus to ground. The bus can be terminated at one or both ends. Low bus pin current allows up to 27 driver/receiver pairs to utilize a common bus. The bus loading is unchanged when  $V_{CC} = 0V$ . The receivers incorporate tight thresholds for better bus noise immunity. One two-input NOR gate is included to disable all drivers in a package simultaneously.

### Features

- 4 separate driver/receiver pairs per package
- Guaranteed minimum bus noise immunity of 0.6V, 1.1V typ
- Temperature insensitive receiver thresholds track bus logic levels
- $30\mu A$  typical bus terminal current with normal  $V_{CC}$  or with  $V_{CC} = 0V$
- Open collector driver output allows wire-OR connection
- High speed
- Series 74 TTL compatible driver and disable inputs and receiver outputs

### Connection Diagram

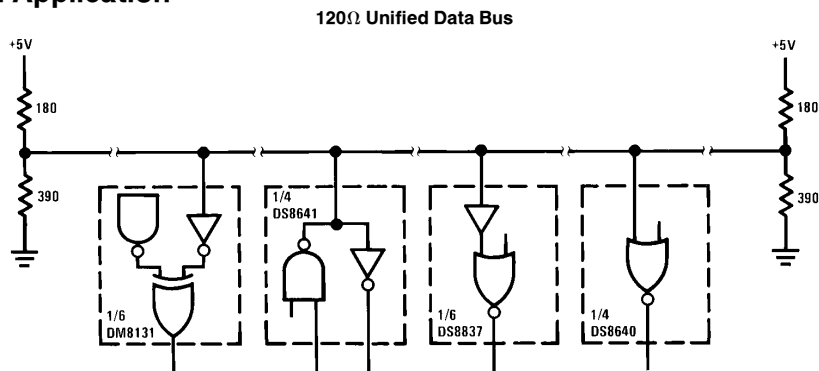


TL/F/5806-1

Top View

Order Number DS8641N  
See NS Package Number N16A

### Typical Application



TL/F/5806-2

## Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input and Output Voltage	5.5V
Storage Temperature Range	−65°C to +150°C
Maximum Power Dissipation* at 25°C	
Cavity Package	1433 mW
Molded Package	1362 mW
Lead Temperature (Soldering, 4 seconds)	260°C

## Operating Conditions

	Min	Max	Units
Supply Voltage, (V <sub>CC</sub> )			
DS8641	4.75	5.25	V
Temperature Range, (T <sub>A</sub> )			
DS8641	0	+70	°C

\*Derate molded package 10.9 mW/°C above 25°C.

## Electrical Characteristics

The following apply for V<sub>MIN</sub> ≤ V<sub>CC</sub> ≤ V<sub>MAX</sub>, T<sub>MIN</sub> ≤ T<sub>A</sub> ≤ T<sub>MAX</sub> unless otherwise specified (Notes 2 and 3)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>DRIVER AND DISABLE INPUTS</b>						
V <sub>IH</sub>	Logical "1" Input Voltage		2.0			V
V <sub>IL</sub>	Logical "0" Input Voltage				0.8	V
I <sub>I</sub>	Logical "1" Input Current	V <sub>IN</sub> = 5.5V			1	mA
I <sub>IH</sub>	Logical "1" Input Current	V <sub>IN</sub> = 2.4V			40	μA
I <sub>IL</sub>	Logical "0" Input Current	V <sub>IN</sub> = 0.4V			−1.6	mA
V <sub>CL</sub>	Input Diode Clamp Voltage	I <sub>DIS</sub> = −12 mA, I <sub>IN</sub> = −12 mA, I <sub>BUS</sub> = −12 mA, T <sub>A</sub> = 25°C		−1	−1.5	V
<b>DRIVER OUTPUT/RECEIVER INPUT</b>						
V <sub>OLB</sub>	Low Level Bus Voltage	V <sub>DIS</sub> = 0.8V, V <sub>IN</sub> = 2V, I <sub>BUS</sub> = 50 mA		0.4	0.7	V
I <sub>IHB</sub>	Maximum Bus Current	V <sub>IN</sub> = 0.8V, V <sub>BUS</sub> = 4V, V <sub>CC</sub> = V <sub>MAX</sub>		30	100	μA
I <sub>ILB</sub>	Maximum Bus Current	V <sub>IN</sub> = 0.8V, V <sub>BUS</sub> = 4V, V <sub>CC</sub> = 0V		2	100	μA
V <sub>IH</sub>	High Level Receiver Threshold	V <sub>IND</sub> = 0.8V, V <sub>OL</sub> = 16 mA	1.70	1.50		V
V <sub>IL</sub>	Low Level Receiver Threshold	V <sub>IND</sub> = 0.8V, V <sub>OH</sub> = −400 μA		1.50	1.30	V
<b>RECEIVER OUTPUT</b>						
V <sub>OH</sub>	Logical "1" Output Voltage	V <sub>IN</sub> = 0.8V, V <sub>BUS</sub> = 0.5V, I <sub>OH</sub> = −400 μA	2.4			V
V <sub>OL</sub>	Logical "0" Output Voltage	V <sub>IN</sub> = 0.8V, V <sub>BUS</sub> = 4V, I <sub>OL</sub> = 16 mA		0.25	0.4	V
I <sub>OS</sub>	Output Short Circuit Current	V <sub>DIS</sub> = 0.8V, V <sub>IN</sub> = 0.8V, V <sub>BUS</sub> = 0.5V, V <sub>OS</sub> = 0V, V <sub>CC</sub> = V <sub>MAX</sub> , (Note 4)	−18		−55	mA
I <sub>CC</sub>	Supply Current	V <sub>DIS</sub> = 0V, V <sub>IN</sub> = 2V, (per Package)		50	70	mA

## Switching Characteristics $T_A = 25^\circ\text{C}$ , $V_{CC} = 5\text{V}$ , unless otherwise indicated

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$t_{PD}$	Propagation Delays (Note 7)	(Note 5)				
	Disable to Bus "1"			19	30	ns
	Disable to Bus "0"			15	30	ns
	Driver Input to Bus "1"			17	25	ns
	Driver Input to Bus "0"			17	25	ns
	Bus to Logical "1" Receiver Output	(Note 6)		20	30	ns
	Bus to Logical "0" Receiver Output			18	30	ns

**Note 1:** "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

**Note 2:** Unless otherwise specified min/max limits apply across the  $0^\circ\text{C}$  to  $+70^\circ\text{C}$  range for the DS8641. All typical values are for  $T_A = 25^\circ\text{C}$  and  $V_{CC} = 5\text{V}$ .

**Note 3:** All currents into device pins shown as positive, out of device pins as negative, all voltages referenced to ground unless otherwise noted. All values shown as max or min on absolute value basis.

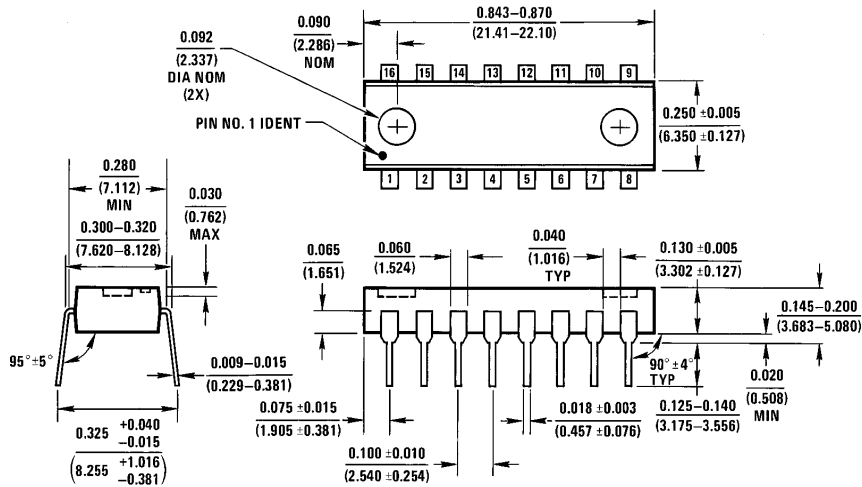
**Note 4:** Only one output at a time should be shorted.

**Note 5:**  $91\Omega$  from bus pin to  $V_{CC}$  and  $200\Omega$  from bus pin to ground.  $C_{LOAD} = 15\text{ pF}$  total. Measured from  $V_{IN} = 1.5\text{V}$  to  $V_{BUS} = 1.5\text{V}$ ,  $V_{IN} = 0\text{V}$  to  $3\text{V}$  pulse.

**Note 6:** Fan-out of 10 load,  $C_{LOAD} = 15\text{ pF}$  total. Measured from  $V_{IN} = 1.5\text{V}$  to  $V_{OUT} = 1.5\text{V}$ ,  $V_{IN} = 0\text{V}$  to  $3\text{V}$  pulse.

**Note 7:** The following apply for  $V_{CC} = 5\text{V}$ ,  $T_A = 25^\circ\text{C}$  unless otherwise specified.

# Physical Dimensions inches (millimeters) (Continued)



**Molded Dual-In-Line Package (N)**  
**Order Number DS8641N**  
**NS Package Number N16A**

N16A (REV E)

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